

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6238860

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHELDON SCHWARTZ	10/12/2016
TAO WANG	09/26/2016
MINGYU WANG	09/13/2016
ZISHENG CAO	09/01/2016
RECEIVING PARTY DATA	
Name:	SZ DJI TECHNOLOGY CO., LTD.
Street Address:	6/F HKUST SZ IER BLDG., NO. 9 YUEXING 1ST ROAD
Internal Address:	HI-TECH PARK (SOUTH), NANSHAN DISTRICT
City:	SHENZHEN CITY
State/Country:	CHINA
Postal Code:	518057
PROPERTY NUMBERS Total: 3	
Property Type	Number
Application Number:	15942862
Application Number:	16270122
Application Number:	16939653
CORRESPONDENCE DATA	
Fax Number:	(202)408-4400
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2024084000
Email:	michelle.murray@finnegan.com
Correspondent Name:	FINNEGAN HENDERSON
Address Line 1:	901 NEW YORK AVENUE, NW
Address Line 4:	WASHINGTON, D.C. 20001
ATTORNEY DOCKET NUMBER:	13156.0050-03000
NAME OF SUBMITTER:	MICHELLE MURRAY
SIGNATURE:	/Michelle Murray/
DATE SIGNED:	08/06/2020

Total Attachments: 2

source=13156.0050-03_Assignment#page1.tif

source=13156.0050-03_Assignment#page2.tif

ASSIGNMENT

WHEREAS I/We, the below named inventor(s) (hereinafter referred to as Assignor(s)), of an invention entitled:

SYSTEM AND METHOD FOR SUPPORTING SELECTIVE BACKTRACKING DATA RECORDING

as disclosed and claimed in Application No. _____, filed _____, United States Application No. _____, filed _____ (Confirmation No. _____) and/or PCT International Application No. PCT/CN2014/076015, filed April 7, 2015 and;

WHEREAS, **SZ DJI TECHNOLOGY CO., LTD.**, a corporation of China whose post office address is **6/F HKUST SZ IER Bldg., No. 9 Yuexing 1st Road, Hi-Tech Park (South), Nanshan District, Shenzhen City 518057, P.R. China** (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to all applications for patents on this invention in all countries throughout the world, including any PCT International Application and all national stage applications based thereon that may be filed, and all patents issued upon such applications in all countries throughout the world;


NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/We, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention, the above-referenced applications that disclose and claim this invention, any PCT International Application and all national stage applications based thereon that may be filed, any other applications for patents filed anywhere in the world that claim this invention, and all divisions, and continuations of any such application, and all patents which may be granted thereon, and all reissues thereof, and all rights to claim priority in any country on the basis of any such applications, and all extensions, renewals, and reissues thereof; and I/We hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys empowered in the Power of Attorney in this application, to insert the filing date and application number of the above-referenced application(s) when known.

IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

1. LEGAL NAME OF SOLE OR FIRST INVENTOR	SIGNATURE	DATE
Sheldon SCHWARTZ		10-12-16
MAILING ADDRESS	RESIDENCE	
6/F HKUST SZ IER Bldg., No. 9 Yuexing 1st Rd., Hi-Tech Park (South), Nanshan District, Shenzhen City 518057, P.R. China		

SOLE/JOINT INVENTION
(Worldwide Rights)
Attorney Docket No. 13156.0050-00000

2. LEGAL NAME OF SECOND INVENTOR, IF ANY Tao WANG	SIGNATURE <i>Tao Wang</i>	DATE <i>Sep 26, 2016</i>
MAILING ADDRESS 6/F HKUST SZ IER Bldg., No. 9 Yuexing 1st Rd., Hi-Tech Park (South), Nanshan District, Shenzhen City 518057, P.R. China		RESIDENCE <i>Shenzhen, China</i>
3. LEGAL NAME OF THIRD INVENTOR, IF ANY Mingyu WANG	SIGNATURE <i>Mingyu Wang</i>	DATE <i>Sep. 13, 2016</i>
MAILING ADDRESS 6/F HKUST SZ IER Bldg., No. 9 Yuexing 1st Rd., Hi-Tech Park (South), Nanshan District, Shenzhen City 518057, P.R. China		RESIDENCE <i>Shenzhen, China</i>
4. LEGAL NAME OF THIRD INVENTOR, IF ANY Zisheng CAO	SIGNATURE <i>Zisheng Cao</i>	DATE <i>2016/9/11</i>
MAILING ADDRESS 6/F HKUST SZ IER Bldg., No. 9 Yuexing 1st Rd., Hi-Tech Park (South), Nanshan District, Shenzhen City 518057, P.R. China		RESIDENCE <i>Shenzhen, China</i>